# DZ2J039

### Silicon epitaxial planar type

For constant voltage / waveform clipper and surge absorption circuit Low noise type

#### Features

- $\bullet$  Excellent rising characteristics of zener current  $I_{\rm z}$
- Eco-friendly Halogen-free package

#### Packaging

Embossed type (Thermo-compression sealing): 3000 pcs / reel (standard)

#### Absolute Maximum Ratings $T_a = 25^{\circ}C$

Parameter	Symbol	Rating	Unit
Repetitive peak forward current	I <sub>FRM</sub>	200	mA
Total power dissipation *	P <sub>T</sub>	200	mW
Junction temperature	Tj	150	°C
Storage temperature	T <sub>stg</sub>	-55 to +150	°C

Note) \*:  $P_T = 200 \text{ mW}$  achieved with a printed circuit board.

#### Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

a							
Parameter	Symbol	Conditions	Min	Тур	Max	Unit	
Forward voltage	V <sub>F</sub>	$I_{\rm F} = 10 \ {\rm mA}$			1.0	V	
Zener voltage *1, 2, 4	VZ	$I_Z = 5 \text{ mA}$	3.71		4.10	V	
Zener operating resistance	R <sub>Z</sub>	$I_Z = 5 \text{ mA}$			130	Ω	
Reverse current	I <sub>R</sub>	$V_R = 1 V$			10	μΑ	
Temperature coefficient of zener voltage *3	SZ	$I_Z = 5 \text{ mA}$		-1.3		mV/°C	

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.

2. Absolute frequency of input and output is 5 MHz.

3. \*1: The temperature must be controlled 25°C for  $V_Z$  measurement.  $V_Z$  value measured at other temperature must be adjusted to  $V_Z$  (25°C) \*2:  $V_Z$  guaranteed 20 ms after current flow.

\*3:  $T_i = 25^{\circ}C$  to  $150^{\circ}C$ 

\*4: Rank classification

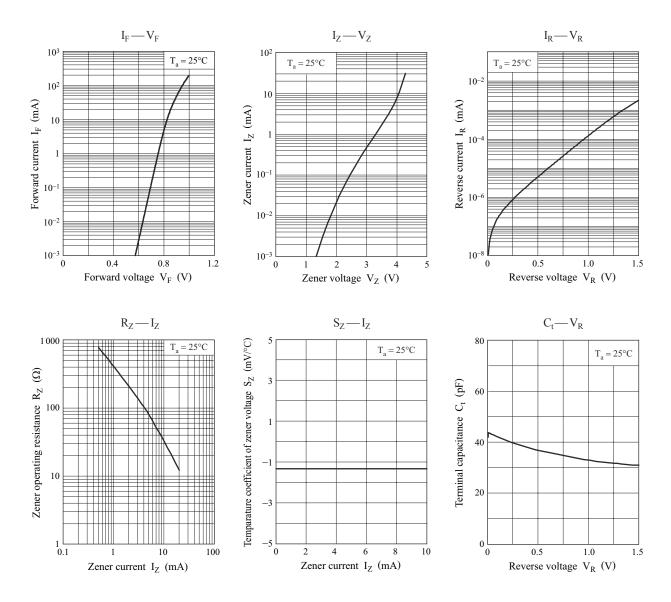
Code	М	0
Rank	М	No-rank
Vz	3.80 to 4.00	3.71 to 4.10
Marking Symbol	7U	7J

#### Package

- Code
- SMini2-F5-B
- Pin Name
- 1. Cathode
- 2. Anode
- Marking Symbol: 7J, 7U

#### DZ2J039

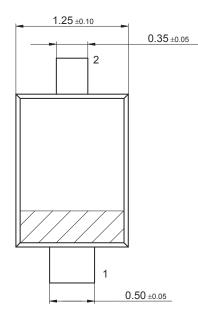
### **Panasonic**



### SMini2-F5-B

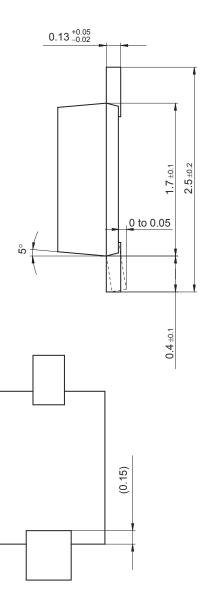
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Unit: mm



0.7 ±0.1

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